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(9)

Spec. No. JENF243A-9122P-01

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Chip Ferrite Bead BLM18

1.Scope

This reference specification applies to Chip Ferrite Bead BLM18_UZ Series for Automotive Electronics based on AEC-Q200 except for Power train and Safety.

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(8)

2.Part Numbering

(ex.) <u>BL</u> <u>M</u> <u>18</u> <u>AG</u> <u>121</u> <u>S</u> <u>Z</u> (1) (2) (3) (4) (5) (6) (7) (1)Product ID (4)Characteristics (2)Type (5)Typical Impedance at (3)Dimension (L×W) (6)Performance

(4)Characteristics
(5)Typical Impedance at 100MHz
(6)Performance
(7)Category(for Automotive Electronics)
(8)Numbers of Circuit
(9)Packaging (D:Taping)

3.Rating

Customer Part Number	omer MURATA (at 10		(Rated Current (mA)		DC Resistance (Ω max.) (*1) (refer to below comment) Initial Values Values After		ESD Rank 2:2kV
			Typical	at 85°C	at 125°C	Values	Testing		
	BLM18PG300SZ1D	20 min.	30	10	00	0.05	0.10		
	BLM18PG330SZ1D	33±25%	33	3000* ²	1000* ²	0.025	0.050		
	BLM18PG600SZ1D	40 min.	60	10	00	0.1	0.2		
	BLM18PG121SZ1D	120±25%	120	2000*2	1000* ²	0.05	0.10		
	BLM18PG181SZ1D	180±25%	180	1500* ²	1000* ²	0.09	0.18		
	BLM18PG221SZ1D	220±25%	220	1400 ^{*2}	1000* ²	0.10	0.14		
	BLM18PG331SZ1D	330±25%	330	1200 ^{*2}	1000 ^{*2}	0.15	0.20		
	BLM18PG471SZ1D	470±25%	470	10	00	0.20	0.26		
	BLM18SP300SZ1D	30±10	30	6000*1	4000*1	0.008	0.010	For DC	
	BLM18SP101SZ1D	100±25%	100	3700*1	2500 ^{*1}	0.022	0.026	power line	
	BLM18SP221SZ1D	220±25%	220	2800*1	1900 ^{*1}	0.040	0.048		
	BLM18SP601SZ1D	600±25%	600	1500 ^{*1}	1000*1	0.140	0.168		2
	BLM18SP102SZ1D	1000±25%	1000	1200*1	800*1	0.185	0.222		
	BLM18KG221SZ1D	220±25%	220	2200*2	1500* ²	0.050	0.060		
	BLM18KG331SZ1D	330±25%	330	1700* ²	1200 ^{*2}	0.080	0.095		
	BLM18KG471SZ1D	470±25%	470	1500* ²	1000* ²	0.130	0.145		
	BLM18KG601SZ1D	600±25%	600	1300* ²	1000* ²	0.150	0.165		
	BLM18KG102SZ1D	1000±25%	1000	1000 ^{*2}	800 ^{*2}	0.200	0.230		
	BLM18AG121SZ1D	120±25%	120	8	00	0.18	0.28		
	BLM18AG151SZ1D	150±25%	150	-	00	0.25	0.35	For	
	BLM18AG221SZ1D	220±25%	220	7	00	0.25	0.35	For general use	
	BLM18AG331SZ1D	330±25%	330	6	00	0.30	0.40	general use	
	BLM18AG471SZ1D	470±25%	470	5	50	0.35	0.45		



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Customer Part Number	MURATA Part Number	Impedance (Ω) (at 100MHz) (*1) (refer to below comment)		Rated Current (mA)		DC Resistance (Ω max.) (*1) (refer to below comment) Initial Values		. Remark	ESD Rank 2:2kV
			Typical	at at 85℃ 125℃	Values	After Testing			
	BLM18AG601SZ1D	600±25%	600	5	00	0.38	0.48	For	
	BLM18AG102SZ1D	1000±25%	1000	4	50	0.50	0.60	general use	
	BLM18BB050SZ1D	5±25%	5	8	00	0.05	0.10		=
	BLM18BA050SZ1D	5±25%	5	5	00	0.2	0.3]	
	BLM18BB100SZ1D	10±25%	10	7	00	0.10	0.20		
	BLM18BA100SZ1D	10±25%	10	5	00	0.25	0.35		
	BLM18BB220SZ1D	22±25%	22	7	00	0.20	0.30		
	BLM18BA220SZ1D	22±25%	22		00	0.35	0.45	1	
	BLM18BB470SZ1D	47±25%	47		00	0.25	0.35	1	
	BLM18BD470SZ1D	$47\pm25\%$	47		600 600	0.20	0.00	1	
	BLM18BD470SZ1D BLM18BA470SZ1D	47±25%	47		00	0.55	0.4	1	
	BLM18BB600SZ1D	60±25%	60		00	0.35	0.05	1	
	BLM18BA750SZ1D	75±25%	75	-	00	0.23	0.33	-	
	BLM18BB750SZ1D	75±25%	75	-	00	0.30	0.00	-	
	BLM18BB121SZ1D	120±25%	120	-	50	0.30	0.40	-	
	BLM18BD121SZ1D	120±25%	120	-	00	0.30	0.40	-	
	BLM18BA121SZ1D	120±25%	120		00	0.9	1.0	For	
	BLM18BB141SZ1D	140±25%	140		00	0.35	0.45	high speed	
	BLM18BB151SZ1D	150±25%	140		.50	0.33	0.43	signal line	
	BLM18BD151SZ1D	150±25%	150		00	0.37	0.47		
	BLM18BB221SZ1D	220±25%	220		.50	0.45	0.55	-	
			220	-				-	
	BLM18BD221SZ1D	220±25%	330		50	0.45	0.55	-	2
	BLM18BB331SZ1D	330±25%			00	0.58		-	
	BLM18BD331SZ1D	330±25%	330		50	0.5	0.6	_	
	BLM18BD421SZ1D	420±25%	420		50	0.55	0.65	_	
	BLM18BB471SZ1D	470±25%	470	-	00	0.85	0.95	_	
	BLM18BD471SZ1D	470±25%	470		50	0.55	0.65	_	
	BLM18BD601SZ1D	600±25%	600		00	0.65	0.75	_	
	BLM18BD102SZ1D	1000±25%	1000		00	0.85	0.95	4	
	BLM18BD152SZ1D	1500±25%	1500		50	1.2	1.3	_	
	BLM18BD182SZ1D	1800±25%	1800		50	1.5	1.6	_	
	BLM18BD222SZ1D	2200±25%	2200		50	1.5	1.6	-	
	BLM18BD252SZ1D	2500±25%	2500		50	1.5	1.6		=
	BLM18SG260TZ1D	26±25%	26		1000* ²	0.007	0.012	_	
	BLM18SG700TZ1D	70±25%	70		1000* ²	0.020	0.030	4	
	BLM18SG121TZ1D	120±25%	120		1000* ²	0.025	0.035	4	
	BLM18SG221TZ1D	220±25%	220		1000* ²	0.040	0.055	4	
	BLM18SG331TZ1D	330±25%	330		1000* ²	0.070	0.085	For DC	
	BLM18SN220TZ1D	22±7%	22		5000* ²	0.004	0.005	power line	
	BLM18KG260TZ1D	26±25%	26		4000 ^{*2}	0.007	0.012	(Thin type)	
	BLM18KG300TZ1D	30±25%	30		3300* ²	0.010	0.015	_	
	BLM18KG700TZ1D	70±25%	70		2200* ²	0.022	0.032		
	BLM18KG101TZ1D	100±25%	100		1900* ²	0.030	0.040		
	BLM18KG121TZ1D	120±25%	120	3000* ²	1900* ²	0.030	0.040		

• Operating Temperature : -55°C to +125°C

• Storage Temperature : -55°C to +125°C

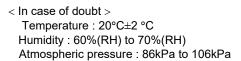


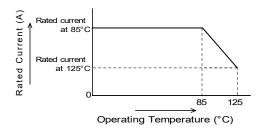
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(*1)

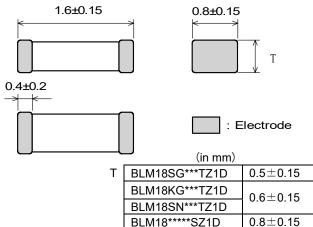
Standard Testing Conditions

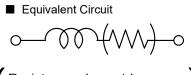
- < Unless otherwise specified > Temperature : Ordinary Temp. (15 °C to 35 °C) Humidity : Ordinary Humidity (25%(RH) to 85%(RH))
 - (*2)In case of Rated current is more than 1A, Rated Current is derated as right figure depending on the operating temperature.





4.Style and Dimensions





Resistance element becomes dominant at high frequencies.

Unit Mass (Typical value)

<u> </u>	/
BLM18****TZ1D	0.004g
BLM18****SZ1D	0.005g

5.Marking

No marking.

6.Specifications

6-1.Electrical Performance

No.	Item	Specification	Test Method
6-1-1	Impedance	Meet item 3.	Measuring Frequency : 100MHz±1MHz Measuring Equipment : KEYSIGHT 4991A or the equivalent Test Fixture : KEYSIGHT 16192A or the equivalent
6-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter For BLM18SN Measuring Equipment : YOKOGAWA 755611 or the equivalent Test Fixture : KEYSIGHT 16044A or the equivalent *Except resistance of the Substrate and Wire

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6-2. Mechanical Performance(based on Table 13 for FILTER EMI SUPPRESSORS/FILTERS) AEC-Q200 Rev.D issued June. 1 2010

No.	Stress	C-Q200 Test Method	Murata Specification / Deviation
4	High Temperature Exposure Temperature Cycling	1000hours at 125 deg C Set for 24hours at room temperature, then measured. 1000cycles -55 deg C to +125 deg C	Meet Table A after testing. <u>Table A</u> Appearance No damage Impedance Within ±30% Change (for BLM18SN (at 100MHz) Within ±50%) DC Resistance Meet item 3. Meet Table B after testing. <u>TableB</u>
		Set for 24hours at room temperature, then measured.	AppearanceNo damageImpedanceWithin ±30%Change(for BLM18SN(at 100MHz)Within ±50%)(for BLM18KGWithin-10%to+50%)DC ResistanceMeet item 3.
5	Destructive	Per EIA469	No defects
7	Physical Analysis Biased Humidity	No electrical tests 1000hours at 85 deg C, 85%RH Apply max rated current.	Meet Table C after testing. <u>TableC</u>
			AppearanceNo damageImpedanceWithin ±30%Change(for BLM18KG/SN(at 100MHz)Within ±50%)DCMeet item 3.ResistanceMeet item 3.
8	Operational Life	Apply 125 deg C 1000hours Set for 24hours at room temperature, then measured	Meet Table C after testing. If the rated current of parts exceed 1A, the operating temperature should be 85 deg C.
9	External Visual	Visual inspection	No abnormalities
10	Physical Dimension	Meet ITEM 4 (Style and Dimensions)	No defects
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable
13	Mechanical Shock	Per MIL-STD-202 Method 213 Condition F 1500g's (14.7N)/0.5ms/ Half sine	Meet Table D after testing.Table DAppearanceNo damageImpedanceChangeWithin ±30%(at 100MHz)DC ResistanceMeet item 3.
14	Vibration	5g's(0.049N) for 20 minutes, 12cycles each of 3 orientations Test from 10-2000Hz.	Meet Table D after testing.
15	Resistance to Soldering Heat	Solder temperature 260C+/-5 deg C Immersion time 10s	Pre-heating:150C +/-10 deg,60s to 90s Meet Table C after testing.

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	A	AEC-Q200	Murata Crastination / Deviation
No.	Stress Test Method		Murata Specification / Deviation
17	ESD	Per AEC-Q200-002	Meet Table D after testing. ESD Rank: Meet Item 3. (Rating)
18	Solderability	Per J-STD-002	Method b : Not Applicable 95% of the terminations is to be soldered.
19	Electrical Characterization	Measured : Impedance	No defects
20	Flammability	Per UL-94	Not Applicable
21	Board Flex	Epoxy-PCB(1.6mm) Deflection 2mm(min) 60s minimum holding tim	Meet Table C after testing.
22	Terminal Strength	Per AEC-Q200-006	No defects
30	Electrical Transient Conduction	Per ISO-7637-2	Not Applicable

7.Specification of Packaging

7-1.Appearance and Dimensions (8mm-wide paper tape)

Part Number	Туре	Appearance and Dimensions
BLM18PG***SZ1D BLM18SP***SZ1D BLM18AG***SZ1D BLM18B****SZ1D BLM18SN***TZ1D BLM18KG****Z1D	8mm- wide Paper tape 4mm-pitch	$\begin{array}{c} 2.0\pm0.05 \\ 4.0\pm0.1 \\ 1.5 \pm0.1 \\ \hline \\ 1.5 \pm0.1 \\ \hline \\ $
BLM18SG***TZ1D	8mm- wide Paper tape 2mm-pitch	2.0 ± 0.05 2.0 ± 0.05 4.0 ± 0.1 $0.15^{\pm0.1}$ $0.05^{\pm}.0^{\pm}$ 0.9^{\pm}

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(1) Taping

Products shall be packaged in the cavity of the base tape of 8mm-wide,4mm-pitch continuously and sealed by top tape and bottom tape.

- (2) The sprocket holes are to the right as the tape is pulled toward the user.
- (3) Spliced point: The base tape and top tape have no spliced point
- (4) Cavity: There shall not be burr in the cavity.
- (5) Missing components number

Missing components number within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

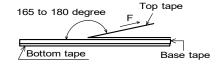
7-2.Tape Strength

(1)Pull Strength

 m easing an	
Top tape	5N min
Bottom tape	SIN MIN.

(2)Peeling off force of Top tape

0.1N to 0.6N (Minimum value is typical.) *Speed of Peeling off:300mm/min



7-3. Taping Condition

(1)Standard quantity per reel

Туре	Quantity per 180mm reel
BLM18(except BLM18SG)	4000 pcs. / reel
BLM18SG	10000 pcs. / reel

(2)There shall be leader-tape (top tape and empty tape) and trailer- tape(empty tape) as follows.

(3)On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.

(4)Marking for reel

The following items shall be marked on a label and the label is stuck on the reel.

(Customer part number, MURATA part number, Inspection number(*1), RoHS marking (*2), Quantity, etc)

Second digit : Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O, N, D Third, Fourth digit : Day

(3) Serial No.

*2) « Expression of RoHS marking »

 $\begin{array}{c} \text{ROHS} - \underbrace{Y}_{(1)} (\underline{\Delta}) \\ \end{array}$

(1) RoHS regulation conformity parts.

(2) MURATĂ classification number

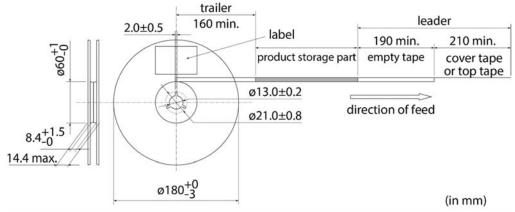
(5)Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

(Customer name, Purchasing order number, Customer part number, MURATA part number,

RoHS discrimination(*2) ,Quantity, etc)

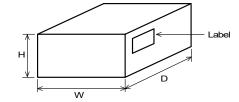
(6)Dimensions of reel and taping(leader-tape, trailer-tape)





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7-4. Specification of Outer Case



Outer Case Dimensions (mm)			Standard Reel Quantity in Outer Case			
W	D	Н	(Reel)			
186	186	93	5			

* Above Outer Case size is typical. It depends on a quantity of an order.

8. 🗥 Caution

8-1.Rating

Do not use products beyond the Operating Temperature Range and Rated Current.

8-2.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

8-3.Fail Safe

Be sure to provide an appropriate fail-safe function on your product to prevent from a second damage that may be caused by the abnormal function or the failure of our products.

8-4. Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1)Aircraft equipment (6)Disaster prevention / crime prevention equipment
- (2)Aerospace equipment
- (7)Traffic signal equipment
- (3)Undersea equipment
- (4)Power plant control equipment
- (5)Medical equipment
- (8)Transportation equipment (trains, ships, etc.) (9)Data-processing equipment
- (10)Applications of similar complexity and /or reliability requirements to the applications listed in the above

9. Notice

This product is designed for solder mounting. Please consult us in advance for applying other mounting method such as conductive adhesive.

9-1.Land pattern designing

- Standard land dimensions
- < For BLM18 series (except BLM18P/BLM18S/BLM18K type) >

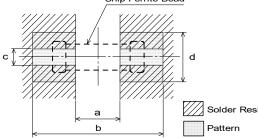
Chip Ferrite Bead



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< For BLM18P/BLM18S/BLM18K type > Chip Ferrite Bead



	Turne	Rated Current	Soldering		h			oad thio dimens	
	Туре	Current	Soluering	а	b	С			
		(A)					18µm	35µm	70µm
	BLM18P	0.5 to 1.5					0.7	0.7	0.7
	BLM18P BLM18S BLM18K	1.7 to 2.5	Flow/	Flow 0.8 Reflow	Flow 2.5 Reflow		1.2	0.7	0.7
		3 to 4				0.7	2.4	1.2	0.7
		5 to 6				0.7	6.4	3.3	1.65
esist	BLM18SN	8		0.7	2.0		-	6.4	3.3
	BLM18SP	1.2 to 6.0					-	6.4	-
	*The excessive heat by land pads may cause deterioration (i							(in r	nm)

at joint of products with substrate.

9-2.Soldering Conditions

Products can be applied to reflow and flow soldering.

(1) Flux, Solder

Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.)
	Do not use water-soluble flux.
Solder	Use Sn-3.0Ag-0.5Cu solder
	Standard thickness of solder paste : 100 μm to 200 μm

(2) Soldering conditions

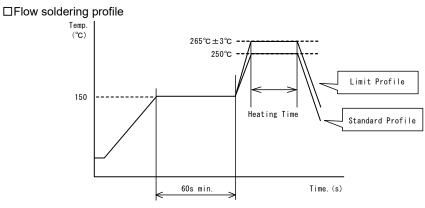
• Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

• Standard soldering profile and the limit soldering profile is as follows.

The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

(3)soldering profile

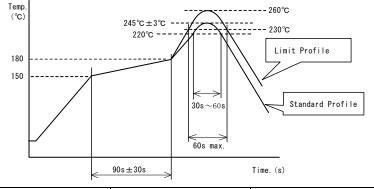


	Standard Profile	Limit Profile	
Pre-heating	150°C、60s min.		
Heating	250°C、4∼6s	265°C±3°C、5s max.	
Cycle of flow	2 times	2 times	

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□Reflow soldering profile



		Standard Profile	Limit Profile	
	Pre-heating	150~180°C 、90s±30s		
	Heating	above 220°C、30s~60s	above 230°C、60s max.	
	Peak temperature	245±3°C	260°C,10s	
Cycle of reflow		2 times	2 times	

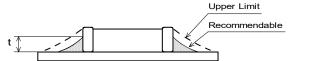
9-3. Reworking with soldering iron

- Pre-heating: 150°C, 1 min
- Soldering iron output: 80W max.
- Tip temperature: 350°C max. • Tip diameter: ϕ 3mm max.
- Soldering time : 3(+1,-0) seconds. • Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

9-4.Solder Volume

Solder shall be used not to be exceeded as shown below.

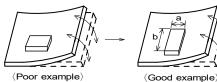


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(T:Chip thickness) Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

9-5.Attention regarding P.C.B. bending

- The following shall be considered when designing and laying out P.C.B.'s.
- (1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage. <Products direction>





Products shall be located in the sideways direction (Length:a<b) to the mechanical stress.

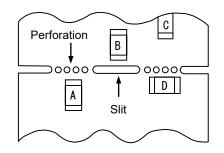
(2)Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board. It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

Contents of Measures	Stress Level	
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1	
(2) Add slits in the board separation part.	A > B	
(3) Keep the mounting position of the component away from the board separation surface.	A > C	

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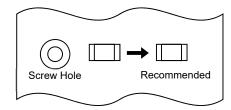
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*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

(3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



9-6.Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

9-7. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl₂, H₂S, NH₃, SO₂, NO₂,etc)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

9-8. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

9-9. Cleaning Conditions

Excessive ultrasonic oscillation during cleaning can cause the PCBs to resonate, resulting in cracked chips or broken solder joints. Before starting your production process,

test your cleaning equipment / process to insure it does not degrade this product.

9-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Twisting

Excessive mechanical stress may cause cracking in the product.

Bending

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9-11. Storage Conditions

- (1)Storage period
 - Use the products within 6 months after delivered.
 - Solderability should be checked if this period is exceeded.
- (2)Storage conditions
 - Products should be stored in the warehouse on the following conditions.
 - Temperature : -10°C to 40°C
 - Humidity : 15% to 85% relative humidity
 - No rapid change on temperature and humidity
 - Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
 - Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Avoid storing the product by itself bare (i.e.exposed directly to air).

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

10. 🗥 Note

(1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.

(2)You are requested not to use our product deviating from the reference specifications.

(3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

P.11/11

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Murata:

BLM18SN220TZ1	BLM18KG700TZ1E	BLM18BD601SZ1	BLM18BA121SZ1D	BLM18BB221SZ1D
BLM18BB331SZ1D	BLM18KG300TZ1D	BLM18SG260TZ1D	BLM18BD221SZ1D	BLM18PG330SZ1D
BLM18BB220SZ1D	BLM18BD182SZ1D	BLM18BD252SZ1D	BLM18BD471SZ1D	BLM18PG471SZ1D
BLM18PG600SZ1D	BLM18BA220SZ1D	BLM18BA470SZ1D	BLM18BB470SZ1D	BLM18BD102SZ1D
BLM18BB100SZ1D	BLM18SG331TZ1D	BLM18BB050SZ1D	BLM18KG101TZ1D	BLM18KG331SZ1D
BLM18BB151SZ1D	BLM18BA100SZ1D	BLM18AG221SZ1D	BLM18AG601SZ1D	BLM18PG181SZ1D
BLM18BA050SZ1D	BLM18BD152SZ1D	BLM18SG221TZ1D	BLM18BB141SZ1D	BLM18BD470SZ1D
BLM18PG300SZ1D	BLM18PG221SZ1D	BLM18BD331SZ1D	BLM18BB121SZ1D	BLM18PG121SZ1D
BLM18AG471SZ1D	BLM18BD222SZ1D	BLM18PG331SZ1D	BLM18BB471SZ1D	BLM18SG121TZ1D
BLM18BA750SZ1D	BLM18BB750SZ1D	BLM18BB600SZ1D	BLM18KG221SZ1D	BLM18AG121SZ1D
BLM18KG121TZ1D	BLM18KG471SZ1D	BLM18KG260TZ1D	BLM18AG331SZ1D	BLM18SG700TZ1D
BLM18AG102SZ1D	BLM18BD121SZ1D	BLM18KG601SZ1D	BLM18BD151SZ1D	BLM18BD421SZ1D
BLM18AG151SZ1D	BLM18KG102SZ1D	BLM18SP101SZ1D	BLM18SP300SZ1D	BLM18SP601SZ1D
BLM18SP102SZ1D	BLM18SP221SZ1D			